

Product Change Notification

(812)-944-6733 / 1-800-SAMTEC9

1. ECN #: 242713

2. Date of Announcement: February 24, 2015

3. Series:

• TFM - .050 X .050 MICRO STRIPS

4. Part #'s Affected

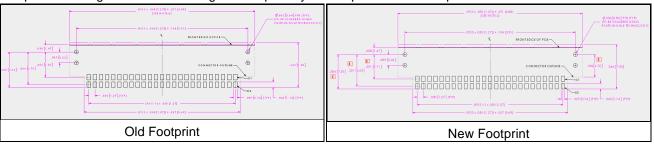
• TFM-1XX-XX-X-DH-XX

5. Description of Change:

Updating the footprint layout to provide better contact to pad alignment.

6. Method of Identifying Change

The product design remains unchanged. The pad layout/footprint has been updated.



7. Reason for Change:

Provides better alignment of part leads to contact pad layout on mating PCB.

8. Impact of Change on Form, Fit, or Function:

- Fit Pad locations in reference to signal pin locations have been updated to better match the product.
- 9. Projected Implementation Date: March 31, 2015